

High Precision Foil Wraparound Surface Mount Chip Resistor

with TCR of ±2 ppm/°C and Load Life Stability of ±0.01% (100 ppm)

FEATURES

 Temperature coefficient of resistance (TCR): ±2.0 ppm/°C typical (-55°C to +125°C,+25°C ref.)

• Tolerance: to ±0.01%

• Power rating: to 400 mW at +70°C

• Load life stability: to ±0.01% at 70°C, 2000 h at

rated power

• Resistance range: 10 Ω to 125 k Ω

• Electrostatic discharge (ESD) up to 25 000 V

• Short time overload: ≤0.01%





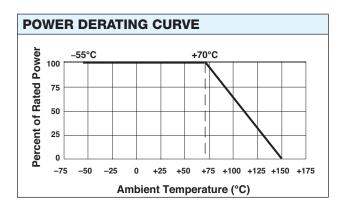
TOLERANCE AND TCR VS. RESISTANCE VALUE(1) (-55°C to +125°C, +25°C Ref.)					
RESISTANCE VALUE (Ω)	TOLERANCE (%)	TYPICAL TCR AND MAX. SPREAD (ppm/°C)			
250 to 125K	±0.01	±2±2			
100 to <250	±0.02	±2±3			
50 to <100	±0.05	±2±3			
25 to <50	±0.1	±2±4			
10 to <25	±0.25	±2±6			

Note

For tighter performances and non-standard values up to 150K, please contact VFR application engineering using the e-mail address in the footer below.

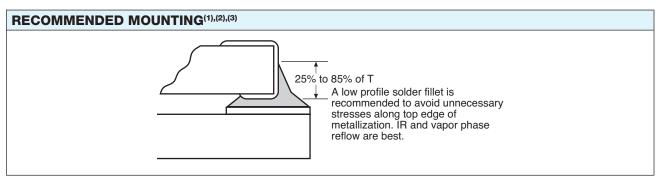
SPECIFICATIONS				
CHIP SIZE	RATED POWER (mW) at +70°C	MAX. WORKING VOLTAGE ≤√P×R	RESISTANCE RANGE (Ω)	MAXIMUM WEIGHT (mg)
0805	100	28 V	10 to 8K	6
1206	150	61 V	10 to 25K	11
1506	200	78 V	10 to 30K	12
2010	300	145 V	10 to 70K	27
2512	400	220 V	10 to 125K	40





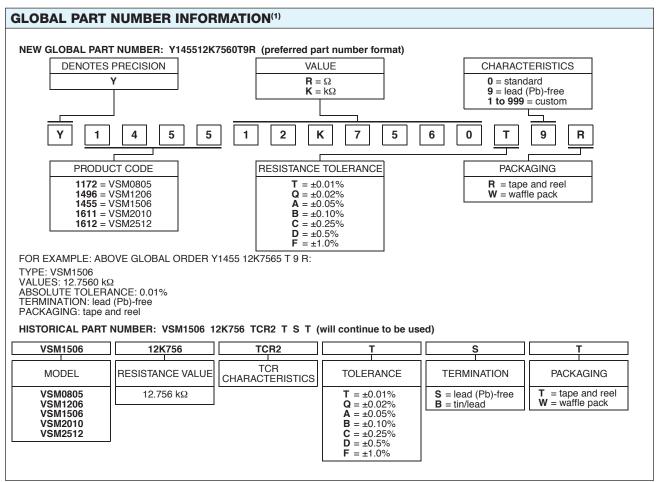
PERFORMANCES					
TEST OR CONDITIONS	MIL-PRF-55342 CHARACTERISTIC E ΔR LIMITS	TYPICAL ΔR LIMITS	MAXIMUM ΔR LIMITS ⁽¹⁾		
Thermal Shock, 100×(-65°C to +150°C)	±0.1%	±0.005% (50 ppm)	±0.02% (200 ppm)		
Low Temperature Operation, -65°C, 45 min at P _{nom}	±0.1%	±0.01% (100 ppm)	±0.02% (200 ppm)		
Short Time Overload, 6.25 × Rated Power, 5 s	±0.1%	±0.01% (100 ppm)	±0.02% (200 ppm)		
High Temperature Exposure, +150°C, 100 h	±0.1%	±0.01% (100 ppm)	±0.03% (300 ppm)		
Resistance to Soldering Heat	±0.2%	±0.005% (50 ppm)	±0.01% (100 ppm)		
Moisture Resistance	±0.2%	±0.005% (50 ppm)	±0.03% (300 ppm)		
Load Life Stability +70°C for 2000 h at Rated Power	±0.5%	±0.005% (50 ppm)	±0.01% (100 ppm)		

 $^{^{(1)}}$ As shown +0.01 Ω to allow for measurement errors at low values.



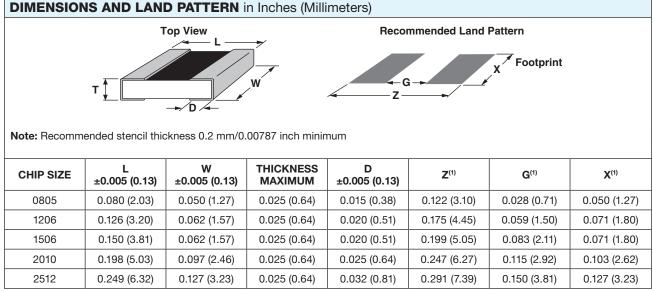
- Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction
- Vacuum pick up is recommended for handling
- Soldering iron may damage the resistor





Note

⁽¹⁾ For non-standard requests, please contact application engineering.



Note

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⁽¹⁾ Land pattern dimensions are per IPC-7351A